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Form PTO-1595 (Rev 09/04) OMB No 0651-0027 (exp 6/30/2005)	03/02/2011	U.S. DEPARTMENT OF COMM United States Patent and Trademark		
	03/11/20	11 :	ET	
To the Director of the U.S. Patent a	1 32002 NEW SEITS IIII 2001 NOV.		documents or the nev	address(es) below
1. Name of conveying party(ies,	10361968	2	ress of receiving par	ty(ies)
YUKI SUGIUE				
	١,	Name:	SONY CORPOR	RATION
	1	nternal Address		
Execution Date(s) February 17, 2011		Street Address:		
Additional name(s) of conveying party(ies) attach	ned? Yes X No	1-7-1 Konan,	Minato-ku	
3. Nature of Conveyance:	Tokyo 108-0075			
X Assignment Merger		JAPAN		
Security Agreement	Change of Name	~ .tu		
Government Interest Assignment		City State		
Executive Order 9424, Confirmatory License				
		Country: Zip Additional name(s) & address(es) Yes Y No		
Other		attached	d address(es)	Yes X No
Addi 5. Name and address to whom correspi concerning document should be mai		<u> </u>	X No	1
Name Dennis M. Sn	<u>L</u>	patents involve	9:	
LERNER, DAVID, 1	LITTENBERG,			
KRUMHOLZ & MI	ENTLIK, LLP 7.	. Total fee (37 CF	R 1 21(h) & 3 41) \$	40.00
Internal Address Atty Dkt SONYJP 3 0-2446		Authorized to be charged by credit card		
Street Address 600 South Avenue West		Authorizon	d to be observed to do	
		X Authorized to be charged to deposit account		
		Enclosed		
		None requ	ired (government inte	rest not affecting titl
City Westfield	8.	. Payment Inform	ation	
State NJ Zip: 07090		a. Credit Card	Last 4 Numbers	
Phone Number (908) 51		03/11/201年初開始 D00000016 121095 129326		
Fax Number (908) 654	4-0415 b Deposit Account Number 49, 99 0412-1095			
	dlkm.com	Authorized Use	Pr Name Dennis N	1. Smid, Esq.
3. Signature:				
	Signatura			h 2, 2011
Dennis M Smid	Signature	Tak		Date
Name of Pers			al number of pages incl et, attachments, and do	

PATENT REEL: 025942 FRAME: 0506

Attorney Docket No. SONYJP 3.0-2446 SONY Ref. No.: S11P0484US00

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in ELECTRONIC DEVICE AND INFORMATION PROCESSING PROGRAM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in. to and under said invention, said application disclosing the invention and in. to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries:

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents. Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countness foreign thereto.

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense:

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto,

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record i	in this application to insert the serial number and filing date of this application is		
the spaces that follow. Serial Number:	_, Filing Date:		
This assignment executed on the dates indicated below.			
YUKI SUGIUE			
Name of first or sole inventor TOKYO JAPAN	Execution date of U.S. Patent Application		
Residence of First or sole inventor Juki Sugiue	February 17, 2011		
Signature of first or sole inventor	Date of this assignment		
Name of second inventor	Execution date of U.S. Patent Application		
Residence of second inventor			
Signature of second inventor	Date of this assignment		
Name of third inventor	Execution date of U.S. Patent Application		
Residence of third inventor			
Signature of third inventor	Date of this assignment		

PATENT REEL: 025942 FRAME: 0507